

- RF Filter for GPS Receiver
- Surface-mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

| Rating | Value | Units |
|---|------------|-------|
| Input Power Level | 10 | dBm |
| DC Voltage on any Non-ground Terminal | 3 | V |
| Operating Temperature Range | -40 to +85 | °C |
| Storage Temperature Range in Tape and Reel | -40 to +85 | °C |
| Maximum Soldering Profile, 5 cycles/ 10 seconds maximum | 265 | °C |

1575 MHz **SAW Filter**

SF1186B-4



Electrical Characteristics

| Characteristic | Sym | Notes | Min | Тур | Max | Units | |
|--|---|-------------------|-----|------|-----|-------|--|
| Center Frequency | | | | 1575 | | MHz | |
| Insertion Loss, 1565 - 1585 MHz | IL | | | 2.7 | 4.5 | dB | |
| Amplitude Ripple, 1565 - 1585 MHz | | | | 0.4 | 1.5 | dB | |
| Attenuation, 0 dB Reference: | | | | | | | |
| 0 to 1000 MHz | | | 32 | 34 | | | |
| 1000 to 1435 MHz | | | 32 | 34.5 | | | |
| 1435 to 1525 MHz | | | 22 | 24 | | | |
| 1525 to 1540 MHz | | | 7 | 21 | | | |
| 1610 to 1625 MHz | | | 7 | 16 | | ٩D | |
| 1625 to 1715 MHz | | | 22 | 25.5 | | - dB | |
| 1715 to 1785 MHz | | | 34 | 39 | | | |
| 1785 to 2100 MHz | | | 30 | 34 | | - | |
| 2100 to 2200 MHz | | | 25 | 26.5 | | | |
| 2200 to 2500 MHz | | | 27 | 34 | | | |
| 2500 to 4000 MHz | | | 18 | 32 | | | |
| Source Impedance, Unbalanced | | | | 50 | | Ω | |
| Load Impedance, Balanced | | Z _L 50 | | 52 | | | |
| Case Style | SM3030-8 3.0 x 3.0 mm Nominal Footprint | | | | | | |
| Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator | 905, YWWS | | | | | | |
| Standard Reel Quantity Reel Size 7 Inch | 500 Pieces/Reel | | | | | | |
| Reel Size 13 Inch | 3000 Pieces/Reel | | | | | | |



CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. Notes:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design design. 1.
- 2. 3.

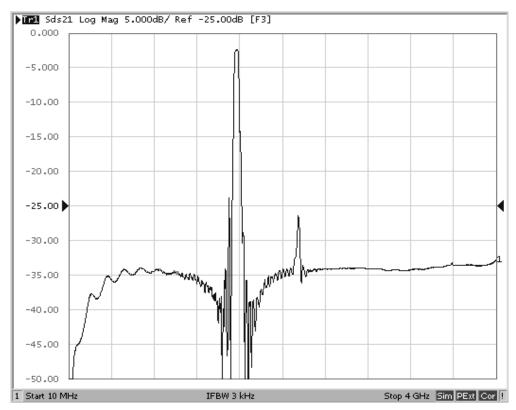
- 4 "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 5.

- 7.
- 8.

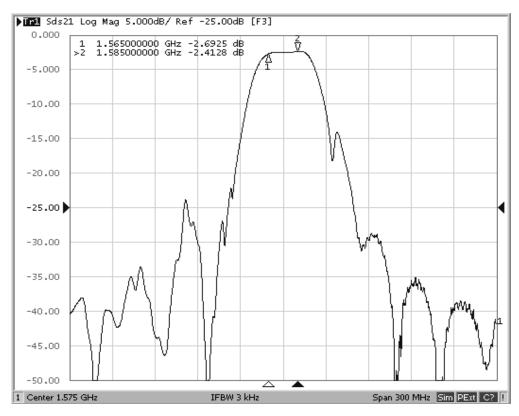
impedance matching design. See Application Note No. 42 for details.

The design, manufacturing process, and specifications of this filter are subject to change. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design. US and international patents may apply. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc. 6.

Filter Wideband Response

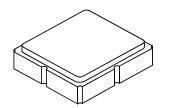


Filter Passband Response



SM3030-8 Case

8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



| Dimension | mm | | | Inches | | | |
|-----------|------|------|------|--------|-------|-------|--|
| Dimension | Min | Nom | Max | Min | Nom | Max | |
| Α | 2.87 | 3.0 | 3.13 | 0.113 | 0.118 | 0.123 | |
| В | 2.87 | 3.0 | 3.13 | 0.113 | 0.118 | 0.123 | |
| С | 1.14 | 1.27 | 1.40 | 0.045 | 0.050 | 0.055 | |
| D | 0.79 | 0.92 | 1.05 | 0.031 | 0.036 | 0.041 | |
| E | 0.62 | 0.75 | 0.88 | 0.024 | 0.029 | 0.034 | |
| F | 0.47 | 0.60 | 0.73 | 0.018 | 0.024 | 0.029 | |
| G | 0.47 | 0.60 | 0.73 | 0.018 | 0.024 | 0.029 | |
| Н | 1.07 | 1.20 | 1.33 | 0.042 | 0.047 | 0.052 | |



1.39 mm + .96 mm

Foot Print Dimensions

Electrical Connections

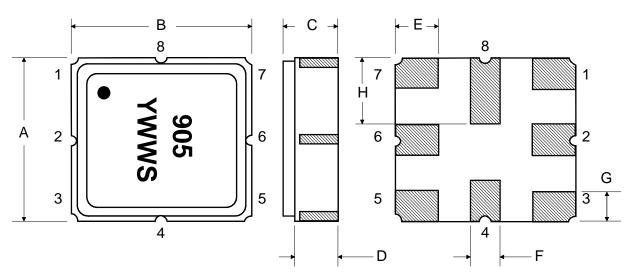
| | Connection | Terminals | | |
|---------------------|------------------|------------|--|--|
| | Unbalanced Input | 2 | | |
| | Balanced Output | 5, 7 | | |
| | Ground | All Others | | |
| Dot Indicates Pin 1 | | | | |

Case Materials

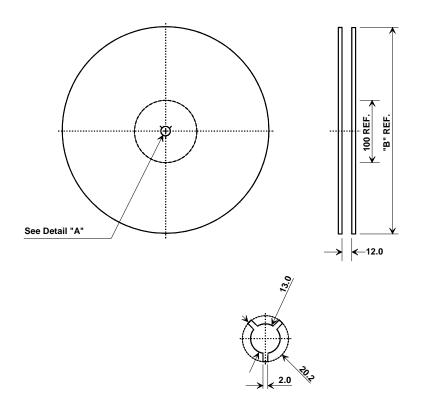
| Materials | | | | |
|-----------------------|--|--|--|--|
| Solder Pad Plating | 0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel | | | |
| Lid Plating | 2.0 to 3.0 µm Nickel | | | |
| Body | Al ₂ O ₃ Ceramic | | | |
| Pb Free | | | | |

TOP VIEW





Tape and Reel Specifications



| 6 | 'B" | Quantity Per Reel |
|--------|-------------|-------------------|
| Inches | millimeters | |
| 7 | 178 | 500 |
| 13 | 330 | 3000 |

COMPONENT ORIENTATION and DIMENSIONS

| Carrier Tape Dimensions | | | | |
|-------------------------|---------|--|--|--|
| Ao | 3.35 mm | | | |
| Во | 3.35 mm | | | |
| Ко | 1.40 mm | | | |
| Pitch | 8.0 mm | | | |
| W | 12.0 mm | | | |

